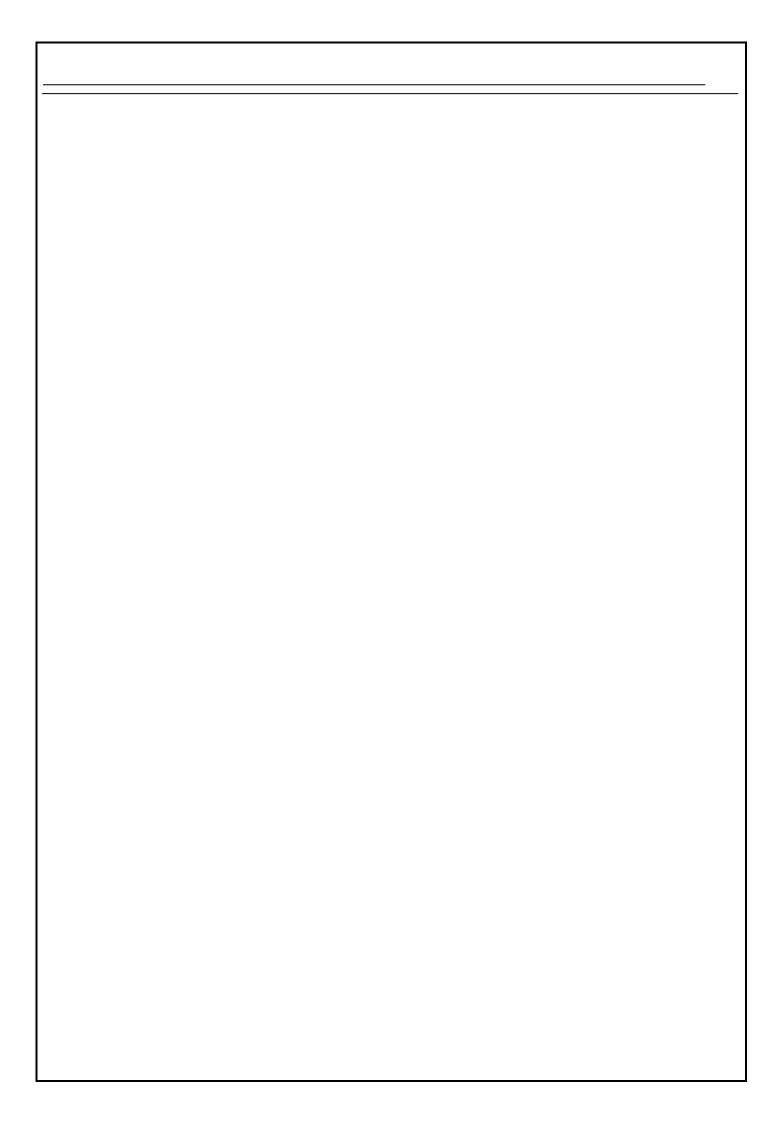
# Quartz crystal specification

制品料号: CS-3225-G12QSA-25.0000MHz

送待承认样:\_\_\_/PCS

责任担当	FA E	技术担当	Patit
营业担当	余志权	检定担当	李淑梅

承认者: GKK LIMITED



#### ■ ELECTRICAL SPECIFICATIONS

#### Standard atmospheric conditions

Unless otherwise specified. The standard range of atmospheric conditions for making measurement and tests are as follow:

Ambient temperature :  $25\pm5^{\circ}$ C Relative humidity:  $40\% \sim 70\%$ 

If there is no doubt the results, measurement shall be made within the following limits:

Ambient temperature :  $25\pm1\,^{\circ}\text{C}$ Relative humidity:  $40\% \sim 70\%$ 

#### Measure equipment

Electrical characteristics measured by S&A 250B or equivalent.

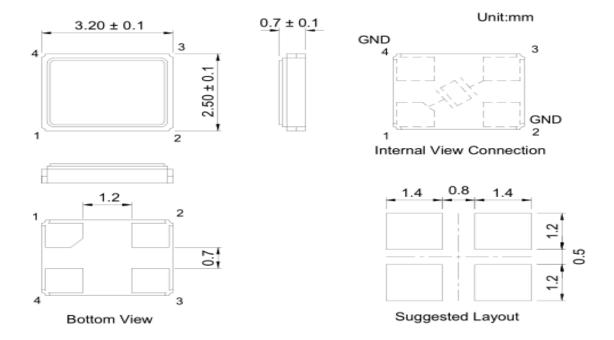
#### Crystal cutting type

The crystal is using AT CUT (thickness shear mode)

	Parameters	SYM	Electrical spec.	UNITS	Notes
1	Nominal Frequency	FL	25.000000	MHz	-
2	Oscillation Mode	-	Fund	-	-
3	Load Capacitance	CL	12	pF	-
4	Frequency Tolerance	-	$\pm 20$	ppm	MAX
5	Frequency Tolerance	-	±30	ppm	Over Operating Temp. Range (Reference 25°C)
6	Operating Temperature	-	-40~+85	°C	-
7	Aging	-	$\pm 0.5$	ppm	1st Year
8	Drive Level	DL	100	μW	-
9	Effective Resistance Rr	Rr	50	Ω	MAX
10	Shunt Capacitance C0	C0	7.0	pF	MAX
11	Motional Capacitance C1	C1	N/A	fF	-
12	Spurious Response	SPDB	-	dB	The spec. is<-3dB(Max.)
					Within+/-5000ppm of
					normial Freq. unless
					otherwise specified.
13	Insulation Resistance	-	500	ΜΩ	at DC 100V
14	Storage Temperature Range	-	-55∼+125	$^{\circ}\!\mathbb{C}$	-
15	Others	-	-	-	-

#### **■ DIMENSION**

- 1. Crystal enclosure seal : Seam Weld
- 2. Crystal enclosure medium: Vacuum



#### **■** MARKING

25.000

MHz

Ref. Purchase Specification

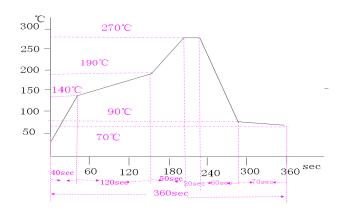
#### ■ SHELF LIFE & STORAGE CONDITIONS

No shipment is allowed by manufactured over 1 year . Storage Conditions:

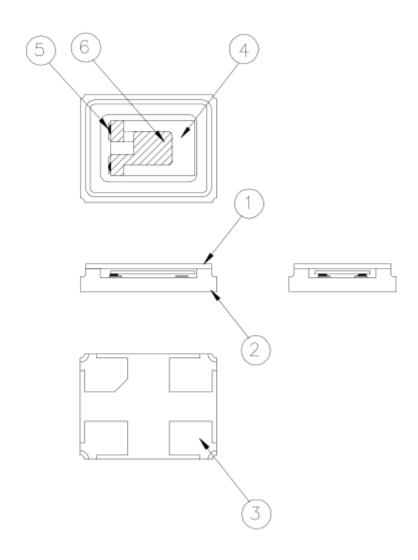
Temp.	Humidity		
25±3℃	40~60%		

#### ■ SUGGESTED REFLOW PROFILE

Total time: 360sec.Max.



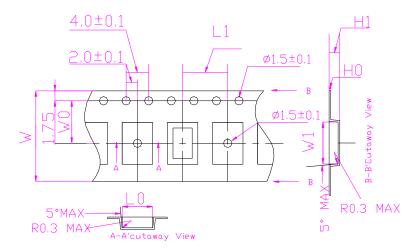
### ■ STRUCTURE ILLUSTRATION



NO	COMPONENTS	MATERIALS	QTY	FINISH/SPECIFICATIONS
1	Cap	Metal (Fe)	1	-
2	Base	Ceramic	1	Color black
3	PAD	Au	4	Tungsten metalize
				+Ni plating
				+Au plating
4	Crystal blank	SiO2	1	-
5	Conductive adhesive	Ag	4	Epoxy resin
6	Electrode	Ag + Cr	2	-

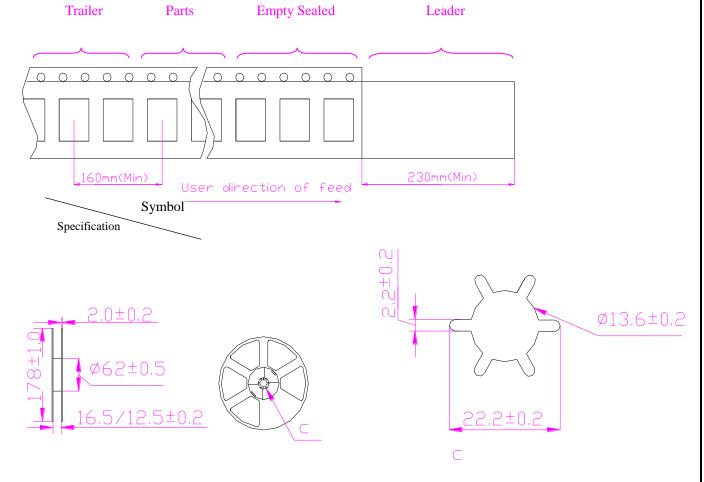
#### **■ PACKING:** (EIA-481-2)

- Shear strength between cover and carrier tape should be 30-100g.
- Carrier tape should be folded over three times with no break at all.



	Dimension Tolerance (mm)						
	W	W0	W1	L0	L1	Н0	H1
3225-8	$8.0 \pm 0.3$	$3.5 \pm 0.1$	3.6±0.1	$2.9 \pm 0.1$	4.0±0.1	$0.3 \pm 0.05$	$1.5 \pm 0.1$

#### **REMARK:**



Unit: mm Standard Reel Quantity is 3,000 pcs per reel.

#### ■ RELIABILITY SPECIFICATIONS

NO	Test Item	Test Methods	Ref.Doc
1	Drop test	75 cm height, fall freely onto stainless plate 3times.	-
2	Mechanical	Device are shocked to half sine wave (1000G) three mutually pendicular	-
	Shock	axes each 3 times.0.5sec.duration time.	
3	Vibration	Frequency range 10~2000Hz	-
		Amplitude 1.52mm	
		Sweep time 20 minute	
		Pendicular axes each test time 4 hours	
		(Total test time 12 hours)	
4	Solderability	Temperature $255^{\circ}\text{C} \pm 5^{\circ}\text{C}$	-
		Immersing depth 0.5mm minimum	
		Immersion time $10\pm0.5$ seconds	
		Flux Rosin resin methyl alcohol	
		Solvent (1:4)	
5	Resistance To	Pre-heat temperature 125 °C	-
	Soldering	Pre-heat time 60~120sec.	
	Heat	Test temperature $260\pm5^{\circ}$ C	
		Test time $5\pm 1$ sec.	
6	High Temp.	$+125^{\circ}\text{C} \pm 2^{\circ}\text{C}$ for $1000 \pm 12 \text{hours}$	-
	Storage		
7	Low temp.	$-40^{\circ}\text{C} \pm 2^{\circ}\text{C}$ for $1000 \pm 12$ hours	
	Storage		
8	Thermal	Total 100 cycles of the following temperature cycle	-
	Cycles		
		1cycle	
		125±3℃ ————————————————————————————————————	
		25℃ / / /	
		-55±3°c +	
		30min. 30min.	
		10min.max	
		TOPHERPIOX	

## 环境管理物质使用规范

Specification of the environment-related substances

范围 Range			
J	产品 <b>Products</b> 最高含量	包材 Packing Material 最高含量	The A. N. C.
禁限物质 Banned	Maximum concentration	Maximum concentration	Test Method
Substances	ppm(mg/kg)	ppm(mg/kg)	
1.镉及镉化合物	5	5	ICP-AES as per EN1122, method
Cadmium and cadmium compounds	3	3	B2001 or other acid digestion.
2.铅及铅化合物	40	100	ICP-AES after as per EPA 3050B
Lead and lead compounds	40	100	or other acid digestion.
3.汞及汞化合物	5	5	ICP-AES after as per EPA 3052
Mercury and mercury compounds		J	or other acid digestion.
4.六价铬化合物	10	10	As per US EPA 7196A and US
Hexavalent-Chromium VI (Cr <sup>+6</sup> )		10	EPA 3060A.
			With reference to USEPA 3540 or
5.聚溴联苯 PBB			USEPA3550. Analysis was performed by
J. 永 侯 联本 PBB	5	5	LPLC/DAD, LC/MS or GC/MS.
Polybrominated biphenyls	3	3	(prohibited by
1 oryotominated orphenyls			2002/95/EC (RoHS),83/261/EEC,
			and76/769/EEC)
			With reference to USEPA3540or
			USEPA3550.
6.聚溴二苯醚 PBDE	_	_	Analysis was performed by
	5	5	HPLC/DAD
Polybrominated diphenyl ethers			LC/MS or GC/MS.(prohibited by 2002/95/EC(RoHS), 83/264/EEC,
			and 76/769/EEC)
7.多氯联苯 (PCB)			and TOTTOTIES
Polychlorinated biphenyl	5	5	
8.多氯化萘 (PCN)	_	_	1
Polychlorinated naphthalene	5	5	
9.氯代烷烃 (CP)	-	5	1
Chiorinated paraffin	5	5	
10.其他有机氯化合物	E	5	1
Other chlorinated organic compounds	5	5	
11.其他有机溴化合物	5	5	
Other brominated organic compounds	3	3	
12.有机锡化合物 (三丁基锡化合物,三			
苯基锡化合物)	5	5	
Organic tin compounds (Tributyl tin	3	3	
category & Triphenyl tin category )			_
13.石棉	5	5	
Asbestos	-	-	4
14.偶氮化合物	5	5	
Azo compounds			
15.甲醛	5	5	
Formaldehyde			
16.聚氯乙烯(PVC)以及聚氯乙烯混合物 Polyginal chloride (PVC) and PVC blands	No detect	No detect	
Polyvinyl chloride (PVC) and PVC blends			
17.包装材料中重金属(汞、镉、六价铬、			
铅、PBB、PBDE)之总量 Heavy metals (mercury, cadmium, lead,	N/A	<100	
Cr <sup>+6</sup> ,PBB and PBDE) in packing materials			
Ci ,rdd and rdde) iii packing materiais			

Lead Free Products are "Directive 2002/95/EC of The European Parliament of 27 January 2003 on the restriction of certain hazardous substances (RoHS) in electrical and electronic equipment" and Sony SS-00259 Compliant.